_ ASS	20047/01/ 001/11/507/11/0	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaration	on enco	mpasses a	ll lower le	evel materials	for which	the item is an assembly the manufacturer has is declaration.
••  •			PC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x					n Type * ribute							
Sup	plier Information														
	pany Name * ren Microwave, Inc.		Company Unique ID		Unique ID Au	uthority	Respo	onse Date	e *		Response	Docume	ent ID		
Contact Name * Michael Lugert			Title - Contact Product Line Manager				Email - Contact * mlugert@anaren.com			Duplicate Contact -> Authorized Representative					
Authorized Representative Michael Lugert			Title - Representative Product Line Manage				Email - Representative * mlugert@anaren.com			Supplier Comments or URL for Additional Information					
	Requester Item Number		Mfr Item Number		Mfr Item Name		Effectiv	e Date	Version	Manuf	nufacturing Site		/eight	UOM	Unit Type
			XDL21-7-110		Xinger Delay	Line, 2.11-2.17 G				East S	Syracuse	5.	.67	g	Each
Alternate Recommendation X		XDL21-7-110S		Xinger Delay Line, 2.11-2.17 G		Alternate Item Co		omments							
Mar	ufacturing Proces	s In	formation												
Terminal Plating / Grid Array Material Termina			Terminal B	ase Alloy	J-STD-020 MSL Ra	ting	Peak Proc	ess Body	y Tempe	rature Max	Time at F	eak Temperat	ure Numb	er of Reflow Cycles	
Tin/Lead (Sn63Pb37) CU Alloy Comments			,	1				260 (			30 secon	ds			

Save the fields in this form to a file Export Data Import fields from a file into this form Import Data	Clear all of the fields on this form  Reset Form  Lock the fields on this form to prevent changes  Lock Supplier Fields
RoHS Material Composition Declaration	Declaration Type * Custom
2002/95/EC Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mas	ous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), s (100 PPM) of homogeneous material for Cadmium
Enter your statement here: See Attachment Below	
RoHS Declaration * 3 - Item(s) does not contain RoHS restricted substances per the definition above except for	or lead in solders and selected exemptions, if any  Supplier Acceptance Accepted
Rollo Boolafation	
exemptions: The items on this form meet the specifications of the Rohs Definition above, exceptions for the item.	t for the following application-specific exemptions. Check the appropriate boxes below for the applicable
1. Mercury in compact fluorescent lamps not exceeding 5 mg per lamp	7c. Lead in electronic ceramic parts (e.g. piezoelectronic devices)
2a. Mercury in straight flourescent lamps for general purposes not exceeding 10 mg iin halophosphate lamps	<ul> <li>8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications</li> <li>banned under Directive 91/338/EEC amending. Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances</li> </ul>
<b>2b</b> . Mercury in straight flourescent lamps for general purposes not exceeding 5 mg in triphosphate lamps with a normal lifetime	9. Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators
<b>2c.</b> Mercury in straight flourescent lamps for general purposes not exceeding 8 mg in triphosphate with long lifetime	10a. DecaBDE in polymeric applications
3. Mercury in straight flourescent lamps for special purposes	10b. Lead in lead-bronze bearing shells and bushes
4. Mercury in other lamps not specifically mentioned in this list	11. Lead used in compliant pin connector systems
5. Lead in glass of cathode ray tubes, electronic components and flourescent tubes	12. Lead as a coating material for a thermal conduction module c-ring
6a. Lead as an alloying element in steel containing up to 0.35% lead by weight	13a. Lead in optical and filter glass
6b. Lead as an alloying element in aluminum containing up to 0.4% lead by weight	13b. Cadmium in optical and filter glass
6c. Lead as an alloying element in copper containing up to 4% lead by weight	14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight
<b>7a.</b> Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85 % by weight or more lead)	15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages
7b. Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications	
Declaration Signature	
<b>Instructions:</b> Complete all of the required fields on all pages of this form. Select the "Acc the declaration (if required by the Requester) and click on Submit Form to have the form retu	epted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign larned to the Requester.
Supplier Digital Signature	· · · · · · · · · · · · · · · · · · ·

## Joint Industry Guide (JIG) Material Composition Declaration for Electronic Products

Instructions: Declare whether the item substances exceed the threshold levels shown in the table and report accordingly. Where threshold levels include the words "intentionally added", substances must be declared if they are added intentionally, regardless of threshold level. For each RoHS substance, identified with dual asterisks (\*\*), report the worst case PPM at the homogeneous material level and optionally the total weight of the substance in the item. For all remaining (non-RoHS) JIG A & B substances, and any additional substances, report the total weight and optionally the PPM at the part level for each item.

				JIG A auto	ofill - No		JIG B	autofill - N	10	All autofill - No	
JIG Category Name		Threshold Level	Above Threshold Level?	If yes, enter total wei worse case PP					ion of	ı of Use	
Level	As defined in the Joint Industry Guide	Intentionally added or PPM	Yes/No	Weight	UoM		PPM				
Α	Asbestos	Intentionally Added	No		mg						
Α	Certain Azo colorants	Intentionally Added	No		mg						
Α	Cadmium/Cadmium Compounds **	75 PPM or Intentionally Added	No		mg						
Α	Hexavalent Chromium/Hexavalent Chromium Compounds **	1000 PPM or Intentionally Added	No		mg						
Α	Lead/Lead Compounds **	1000 PPM or Intentionally Added	Yes	0.0312	g	5,62	23	Tin/Lead	Platin	g	
Α	Lead/Lead Compounds - PVC Cables and Wires Only **	300 PPM	No		mg						
Α	Mercury/Mercury Compounds **	1000 PPM or Intentionally Added	No		mg						
Α	Ozone Depleting Substances - Class I (CFCs, HBFCs, etc.)	Intentionally Added	No		mg						
Α	Ozone Depleting Substances - Class II (HCFCs)	1000 PPM	No		mg						
Α	Polybrominated Biphenyls (PBBs) **	1000 PPM or Intentionally Added	No		mg						
Α	Polybrominated Diphenylethers (PBDEs) **	1000 PPM or Intentionally Added	No		mg						
Α	Polychlorinated Biphenyls (PCBs)	Intentionally Added	No		mg						
Α	Polychlorinated Naphthalenes ( > 3 chlorine atoms)	Intentionally Added	No		mg						
Α	Radioactive Substances	Intentionally Added	No		mg						
Α	Certain Shortchain Chlorinated Paraffins	Intentionally Added	No		mg						
Α	Tributyl Tin (TBT) and Triphenyl Tin (TPT)	Intentionally Added	No		mg						
Α	Tributyl Tin Oxide (TBTO)	Intentionally Added	No		mg						
В	Antimony/Antimony Compounds	1000 PPM	No		mg						
В	Arsenic/Arsenic Compounds	1000 PPM	No		mg						
В	Beryllium/Beryllium Compounds	1000 PPM	No		mg						
В	Bismuth/Bismuth Compounds	1000 PPM	No		mg						
В	Brominated Flame Retardants (other than PBBs or PBDEs)	1000 PPM	No		mg						
В	Nickel (external applications only)	1000 PPM	No		mg						
В	Certain Phthalates	1000 PPM	No		mg						
В	Selenium/Selenium Compounds	1000 PPM	No		mg						
В	Polyvinyl Chloride (PVC)	1000 PPM	No		mg						

## **OTHER Material Composition Declaration**

Requester Instructions: The requester can optionally include additional substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances. The requester should enter additional substances as well as the threshold levels that specify the substance at the item level.

Supplier Instructions: Explicitly declare whether the item exceed the threshold level by selecting Yes or No. If the maximum concentration of any substance exceeds the threshold levels defined by the requester, then the substance content must be reported in total weight and/or worst case PPM, along with a description of material use.

JIG	Category Name	Threshold Level
Other	As defined by the Requester	Defined by the Requester
+ -		

Add Other Material Composition to JIG Tab